

18. The method of claim 17 further comprising the raising of at least one lift pin through the upper body to raise the wafer off of the upper body for removal of the wafer from the wafer chuck.

19. (Amended once) The method of claim 17 wherein processing the wafer includes using the processing fluid to deposit copper material onto the wafer.

20. (Amended once) The method of claim 17 wherein processing the wafer includes using the processing fluid to remove copper material from the wafer.

### REMARKS

In the parent application, serial number 09/293,012, claims 17-20 were cancelled due to a restriction requirement by the examiner. Those claims are now being prosecuted in this divisional application.

The amendment to the written description duplicates those changes made in the parent application to correct minor errors in the text. The amendment to the claims corrects typographical errors, more clearly states the claimed elements by using clearer language, and broadens claim 17. No claim was narrowed by this amendment.

Claim 17 recites that a flexible coupling permits the wafer to tilt, and this tilting permits the wafer to engage the sleeve to form a floor of the vessel to prevent/reduce leaking of the processing fluid. This combination of limitations was not disclosed or

suggested by the references cited in the parent application. Claims 18-20 depend from claim 17 and therefore contain the same allowable elements as claim 17.


# **CONCLUSION**

For the foregoing reasons, Applicant submits that claims 17-20 are now in condition for allowance, and indication of allowance by the Examiner is respectfully requested. If the Examiner has any questions concerning this application, he or she is requested to telephone the undersigned at the telephone number shown below as soon as possible. If this amount is incorrect, please charge any insufficiency or credit any overpayment to Deposit Account No. 02-2666.

Respectfully submitted,

BLAKELY, SOLOKOFF, TAYLOR & ZAFMAN, LLP

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 John Travis  
 Reg. No. 43,203

12400 Wilshire Blvd  
 Seventh Floor  
 Los Angeles, California 90025-1026  
 (512) 330-0844

09825648-040401